

## OXIDATION BEHAVIOR AND ELECTROCHEMICAL CORROSION PERFORMANCE OF Ti<sub>3</sub>Al ALLOY WITH TiAl COATING

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Magnetron-sputter deposition was used to produce Ti–48Al–8Cr–2Ag (at.%) coating on a Ti–24Al–17Nb–0.5Mo (at.%) alloy substrate. Oxidation behavior was studied in air at 900...1000°C. The results indicated that the oxidation rate of sputtered Ti–48Al–8Cr–2Ag nanocrystalline coating was lower than that of the Ti<sub>3</sub>Al alloy at 900°C. The former formed a scale of merely Al<sub>2</sub>O<sub>3</sub> and the latter formed a scale of TiO<sub>2</sub>. However, the Ti–48Al–8Cr–2Ag nanocrystalline coating showed a little bit higher oxidation rate than Ti<sub>3</sub>Al alloy at 1000°C, because outer TiO<sub>2</sub> scale formed and columnar boundaries of the coating gave a larger actual oxidation area than the original alloy. The electrochemical corrosion behavior was investigated in 3.5% NaCl solution at room temperature. The coating showed the excellent electrochemical corrosion resistance in 3.5% NaCl solution, because it exhibited stable passive polarization behavior without any overpassivation phenomena.

**Key words:** *Ti<sub>3</sub>Al, TiAlCrAg nanocrystalline coating, high temperature oxidation, electrochemical corrosion.*

Titanium aluminides are promising intermetallic compounds for high temperature applications especially because of the possible weight reduction of structural components. Experimental evidence [1–3] has shown that titanium aluminides with aluminum content of about 50 at.% form nonprotective TiO<sub>2</sub> + Al<sub>2</sub>O<sub>3</sub> scales rather than dense protective alumina scale. Therefore an attempt was made to protect them against oxidation by coating [4–6]. Recently, several investigations were focused on the oxidation of the Ti–Al alloy by the diffusion coatings formed by pack-codeposition of Al and Si [7–8] and Al Electrodeposition on the surface of Ti–Al [9].

Since a new class of TiAlCr coatings was proposed and they provided excellent oxidation protection for TiAl intermetallics [10–12], they received a considerable interest. The Ag-containing alloys possess relatively high ductility. TiAlCrAg alloys were investigated to exhibit excellent oxidation resistance [13]. Therefore, TiAlCrAg coatings may become a promising protective coating for Ti<sub>3</sub>Al-base intermetallics, and few studies have been focused on it, especially on the electrochemical corrosion. This paper reports on the effect of the TiAlCrAg coating on the high temperature and electrochemical corrosion performance on the Ti<sub>3</sub>Al alloy.

**Experimental procedures.** The Ti–48Al–8Cr–2Ag coating was prepared on the Ti<sub>3</sub>Al alloy by magnetron sputtering technique. The target of 380×126×7 (mm) and the specimens of 10×10×2.5 (mm) were cut from an alloy ingot. The Ti<sub>3</sub>Al alloy specimens were ground down to No.800 emery paper, peened and ultrasonically cleaned in ethanol. The sputtering parameters were as follows: the reaction chamber – 0.5×10<sup>-2</sup> Pa; Argon pressure – 0.2...0.3 Pa; substrate temperature – 200°C; power – 1800 W; sputtering time – 8 h.

The coating possesses a columnar structure with a spherical surface. All sides of the specimens were coated with a thickness of about 20 μm. The deposition procedure, the morphology and microstructure of the coating were narrated in detail elsewhere [14].

Isothermal oxidation test was carried out at 900...1000°C in air. Thermogravimetric Analysis (TGA) was conducted for the characterization of the oxidation kinetics. The oxidized samples were analyzed by scanning electron microscopy (SEM) with energy dispersive X-ray diffraction (EDX).

Electrochemical polarization was carried out in a round bottom polarization cell. The potential of the working electrode was measured against saturated calomel electrode (SCE). A Pt plate was used as a counter electrode. The electrochemical corrosion was investigated using a CS300 potentiostat, interfaced to a computer.

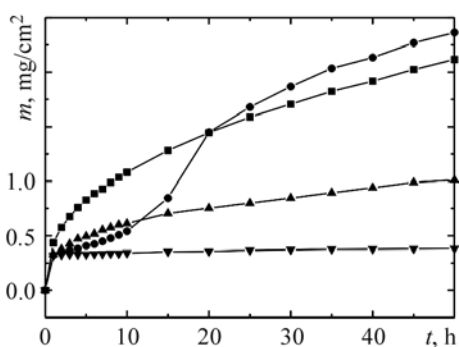


Fig. 1. Isothermal oxidation kinetics of specimens; ● – as-coated, 1000°C; ▼ – as-coated, 900°C; ■ – cast, 1000°C; ▲ – cast, 900°C.

**Results and discussion.** Fig. 1 shows the results of the thermogravimetric analysis for different samples. The sample with Ti-48Al-8Cr-2Ag coating exhibits a lower oxidation rate than the cast Ti<sub>3</sub>Al alloy at 900°C. In the initial stage, Ti-48Al-8Cr-2Ag coating exhibits a lower mass gain than the cast Ti<sub>3</sub>Al based alloy at 1000°C, but with increasing time the weight gain of the coating exceeds the cast Ti<sub>3</sub>Al based alloy after 20 h.

After oxidation in air, the specimens had a greyish colour. Fig. 2a, b shows the surface morphology and cross-sectional microstructure of cast Ti<sub>3</sub>Al alloy after 50 h at 900°C. A continuous TiO<sub>2</sub> scale was formed on the alloy. The thickness of the scale was about 5 μm.

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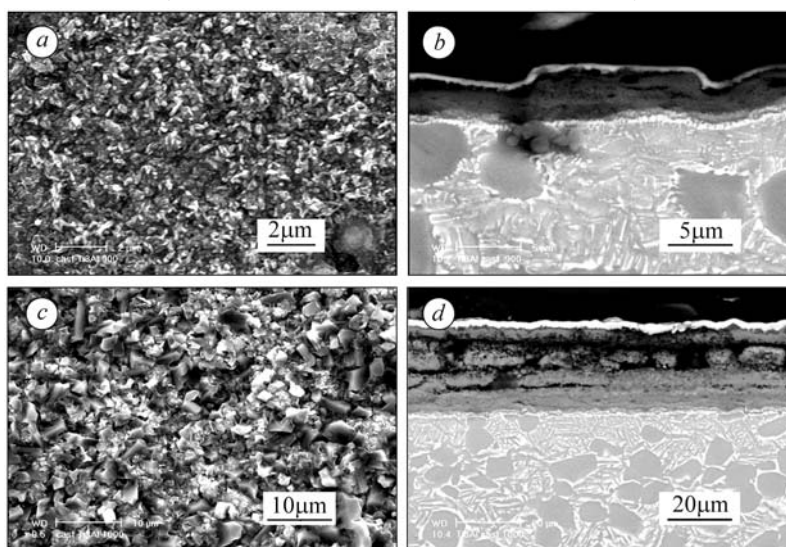


Fig. 2. Cast Ti<sub>3</sub>Al alloy after 50 h oxidation at 900°C (a, b) and 1000°C (c, d): a, c – surface morphology; b, d – cross-sectional microstructure.

Fig. 3a, b shows the surface morphology and cross-sectional microstructure of Ti-48Al-8Cr-2Ag coating after 50 h at 900°C. A needle-shaped Al<sub>2</sub>O<sub>3</sub> scale was formed on the surface continuously, so it provided excellent protection for the alloy at 900°C. Grain size reduction enhanced the formation of a continuous Al<sub>2</sub>O<sub>3</sub> scale and improved oxidation resistance, observed here at 900°C. Due to Al diffusion from the coating to the substrate, a diffusion layer was formed near the substrate at the substrate/coating interface, and diffusion depth was about 5 μm.

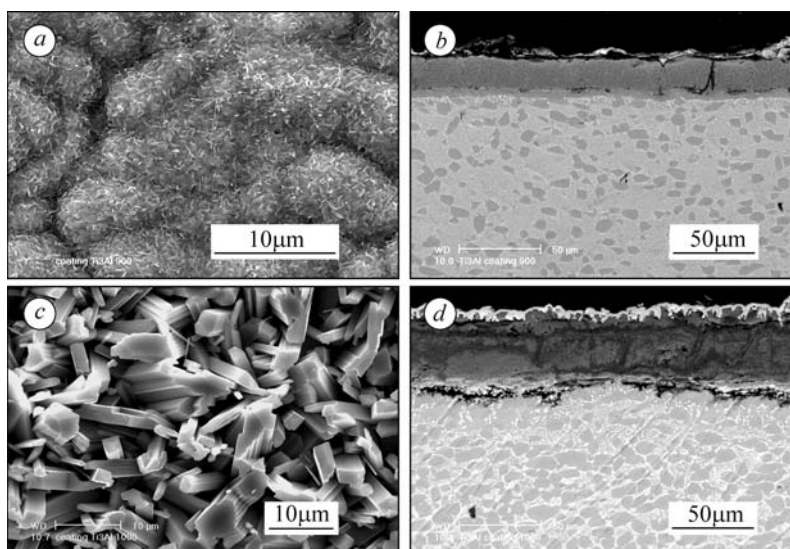


Fig. 3. Cast alloy with Ti-48Al-8Cr-2Ag coating after 50 h oxidation at 900°C (*a, b*) and 1000°C (*c, d*): *a, c* – surface morphology; *b, d* – cross-sectional microstructure.

Fig. 2*c, d* shows the surface morphology and cross-sectional microstructure of cast Ti<sub>3</sub>Al alloy after 50 h at 1000°C. This scale exhibits typical structure of Ti<sub>3</sub>Al alloy oxidized in air. The scale consists mainly of titanium with some incorporated alumina grains. The thickness of Al<sub>2</sub>O<sub>3</sub> + TiO<sub>2</sub> mixture scale was about 35 µm. Some cracks parallel to the sample surface occurred in the scale. The oxide scale detached easily during preparation of the metallographic cross-section. The alloy exhibited higher oxidation rate at 1000°C than at 900°C. EDX analysis revealed that the light zone beneath the scale was Nb rich.

Fig. 3*c, d* shows the surface morphology and cross-sectional microstructure of Ti-48Al-8Cr-2Ag coating after 50 h at 1000°C. A continuous TiO<sub>2</sub> scale was formed on the coating. A band of alumina crystals was present, especially beneath the outer zone of the coarse-grained rutile. In the case of the cross-sectional structure, we can also see that some Al<sub>2</sub>O<sub>3</sub> was formed along the columnar grain boundaries. This partially explained the higher oxidation rate of the coating than that of the substrate under the same conditions. At the same time the outer thin Al<sub>2</sub>O<sub>3</sub> scale indicated Al outward diffusion. Kirkendall voids were present at the coating/substrate interface as shown in Fig. 3*d*, which was the same as the results of the MCrAlY coating on the TiAl alloys [15]. They were mainly caused the different contents of the elements in the coating and the substrate. Although voids have no influence on the oxidation resistance in the present study, they will have a detrimental effect on the coating adherent to substrate, the fatigue properties of the substrate, and the long-term oxidation resistance of the coating. Therefore, diffusion and voids must be considered before it may be used in practice.

The coating oxidized more rapidly than the Ti<sub>3</sub>Al substrate at 1000°C. SEM analysis indicated that the TiO<sub>2</sub> was the outer layer on the coating, and a nearly continuous Al<sub>2</sub>O<sub>3</sub> scale under TiO<sub>2</sub> layer at 1000°C, and the scale on the coating was thinner than that on the substrate, which was different from the result of kinetics curves. There existed the boundaries or free surfaces between columnar, which might induce extra surface area for the coating. Yang [16] studied the influence of columnar microstructure of NiAl coating on its oxidation behavior at 1000°C. The results have revealed the columnar microstructure during oxidation which was the main reason of the high oxidation rate. The influence of columnar microstructure on oxidation behavior in the present study should be similar to that for NiAl coating.

In the present study, a different phenomenon from the traditional research was found. In the past, we also studied oxidation behavior of the TiAl coating on the TiAl alloy. The result showed that predominate  $\text{Al}_2\text{O}_3$  scale was formed on the coating at  $1000^\circ\text{C}$ , and beneath  $\text{Al}_2\text{O}_3$  scale the almost continuous layer of Al-depletion was present [14]. In the present study, the outer layer was not  $\text{Al}_2\text{O}_3$  but  $\text{TiO}_2$  on the coating after oxidation at  $1000^\circ\text{C}$ , partly because of different Al content in the coating and the substrate. After oxidation at  $1000^\circ\text{C}$ , some Al outward diffusion caused the  $\text{Al}_2\text{O}_3$  formation under the  $\text{TiO}_2$  layer. At the same time, due to much higher Al content in the coating than that in the substrate, some Al inward diffusion occurred. Thereby, the initial  $\text{Al}_2\text{O}_3$  scale was formed due to the grain size reduction, and then the Al inward diffusion resulted in the Al activity decrease and Ti activity increased. Therefore,  $\text{TiO}_2$  was formed on the surface due to outward diffusion of Ti along the columnar grain boundary.

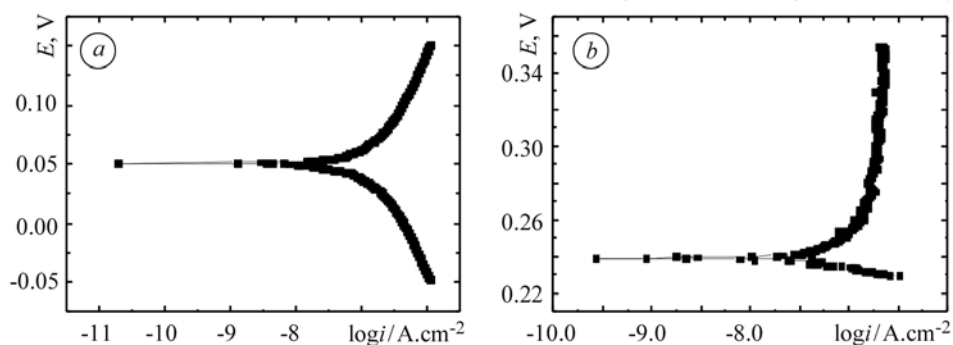


Fig. 4. Potentiodynamic polarization curve of  $\text{Ti}_3\text{Al}$  alloy without (a) and with coating (b) in 3.5% NaCl solution at room temperature.

Potentiodynamic polarization curves for the  $\text{Ti}_3\text{Al}$  alloy and the  $\text{Ti}_3\text{Al}$  alloy with coating are shown in Fig. 4. The nature of polarization curves indicated that the corrosion potential of the alloy was much more negative than of the alloy with coating. The corrosion potential of the alloy is 0.05 V approximately, while the coating 0.24V. In addition, the coating exhibited the passivation phenomena obviously. The passive current density was maintained at about  $10^{-6.7} \text{A/cm}^2$  without any overpassivation. The passive range in the coating exhibits the stable passive behavior. Therefore, the coating showed the excellent protection of the  $\text{Ti}_3\text{Al}$  alloy in the 3.5% NaCl solution at room temperature.

The experimental Tafel plots and polarization resistance ( $R_p$ ) were analyzed. The zero current potential ( $E_{corr}$ ), the cathodic ( $\beta_c$ ) and anodic ( $\beta_a$ ) Tafel slopes, the estimated corrosion current densities ( $i_{corr}$ ) and polarization resistance ( $R_p$ ) are tabulated in the Table.

**Tafel plots determined by Tafel extrapolation method and  $R_p$  by  $R_p$  fitting**

	$R_p$ , $\text{Ohm}\cdot\text{cm}^{-2}$	$\beta_a$ , mV	$\beta_c$ , mV	$i_{corr}$ , $\text{A}\cdot\text{cm}^{-2}$	$E_{corr}$ , V
Alloy	$7.11\cdot 10^4$	129.6	128.8	$2.0\cdot 10^{-7}$	-0.43
Alloy with coating	$3.19\cdot 10^5$	$1.28\cdot 10^6$	22.8	$2.77\cdot 10^{-7}$	-0.26

**CONCLUSIONS**

The sputtered TiAlCrAg nanocrystalline coating showed a lower oxidation rate than the cast TiAlNb alloy at  $900^\circ\text{C}$ , because the former formed the pure  $\text{Al}_2\text{O}_3$  scale and the latter formed the  $\text{TiO}_2$  scale. The Ti-48Al-8Cr-2Ag nanocrystalline coating showed a little bit higher oxidation rate than the  $\text{Ti}_3\text{Al}$  alloy at  $1000^\circ\text{C}$ . The electrochemical corrosion behavior was investigated in 3.5% NaCl solution at room temperature. The alloy sputtered TiAl coating exhibited the stable passive polarization behavior without any overpassivation phenomena. The coating showed the excellent electrochemical corrosion resistance in 3.5% NaCl solution at room temperature.

*РЕЗЮМЕ.* Для виготовлення покривів на основі системи Ti–48Al–8Cr–2Ag (at.%), сформованих на підкладці Ti–24Al–17Nb–0,5Mo (at.%), використовували метод магнетронного розпилення. Характер окиснення досліджували в повітрі при 900...1000°C. Встановлено, що швидкість окиснення напиленого на Ti–48Al–8Cr–2Ag нанокристалічного покриву нижча, ніж на сплаві Ti<sub>3</sub>Al. В результаті окиснення Ti–48Al–8Cr–2Ag утворюється плівка TiO<sub>2</sub>, а після окиснення сплаву Ti<sub>3</sub>Al – плівка Al<sub>2</sub>O<sub>3</sub>. Нанокристалічний покрив, на якому сформували плівку TiO<sub>2</sub>, продемонстрував дещо вищу швидкість окиснення, ніж сплав Ti<sub>3</sub>Al, що пов'язано з тим, що плівка TiO<sub>2</sub> та межі стовпчастих кристалів покриву утворюють значно більшу ділянку реального окиснення, ніж вихідний сплав. Електрохімічну корозію вивчали у 3,5%-му розчині NaCl за кімнатної температури. Покрив був електрохімічно тривкий у ньому через стабільність пасивної поляризації за відсутності перепасивації.

*РЕЗЮМЕ.* Для изготовления покрытий на основе системы Ti–48Al–8Cr–2Ag (at.%), сформированных на подкладке Ti–24Al–17Nb–0,5Mo (at.%), использовали метод магнетронного распыления. Характер окисирования исследовали в воздухе при 900...1000°C. Выявлено, что скорость окисирования напиленного на Ti–48Al–8Cr–2Ag нанокристаллического покрытия меньше, чем на сплаве Ti<sub>3</sub>Al. В результате окисления Ti–48Al–8Cr–2Ag образуется пленка TiO<sub>2</sub>, а после окисления сплава Ti<sub>3</sub>Al – пленка Al<sub>2</sub>O<sub>3</sub>. Нанокристаллическое покрытие, на котором сформировали пленку TiO<sub>2</sub>, продемонстрировало несколько повышенную скорость окисирования, нежели сплав Ti<sub>3</sub>Al, что связано с тем, что пленка TiO<sub>2</sub> и границы столбовых кристаллов покрытия образуют значительно больший участок реального окисирования, чем исходный сплав. Электрохимическую коррозию изучали в 3,5%-ом растворе NaCl при комнатной температуре. Покрытие оказалось электрохимически стойким в нем благодаря стабильности пассивной поляризации при отсутствии перепассивации.

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